



TS98-403CCC

Serial number 09/285,986

AMENDMENT AND RESPONSE TO OFFICE ACTION

TO: COMMISSIONER OF PATENTS AND TRADEMARKS
Washington, D.C. 20231

From : George O. Saile (Reg. No. 19,572)
28 Davis Avenue
Poughkeepsie, NY 12603

Date: March 31, 2003

REF: APPLICANT : Cheu, Shih-Shiung
SERIAL NO. : 09/285,986
ART UNIT : 2813
FILING DATE : 04/05/99
ATT'Y NO. : TSMC98-403
EXAMINER : Berezny, Nema Q.
TITLE : A COST EFFECTIVE POLYIMIDE PROCESS TO
SOLVE PASSIVATION EXTRUSION OR DAMAGE AND SOG
DELAMINATES


Sir:

In response to an office action mailed on 01/23/03
please consider the following amendments and remarks with
respect to the above referenced application.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal service as First
Class mail in an envelop addressed to the Commissioner of
Patents and Trademarks, Washington, D.C. 20231, on
April 22, 2003

Stephen B. Ackerman
(Reg. No 37,761)



Signature

4/22/03

Date

2813
#25
Response
Y Robinson
5/6/03

RECEIVED
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TECHNOLOGY CENTER 2800